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August 2015

FCPF650N80Z — N-Channel SuperFET[®] II MOSFET

FCPF650N80Z

N-Channel SuperFET[®] II MOSFET

800 V, 10 A, 650 m Ω

Features

- R_{DS(on)} = 530 mΩ (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 27 nC)
- Low E_{oss} (Typ. 2.8 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 124 pF)
- 100% Avalanche Tested
- RoHS Compliant
- · ESD Improved Capability

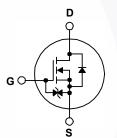
Applications

- AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





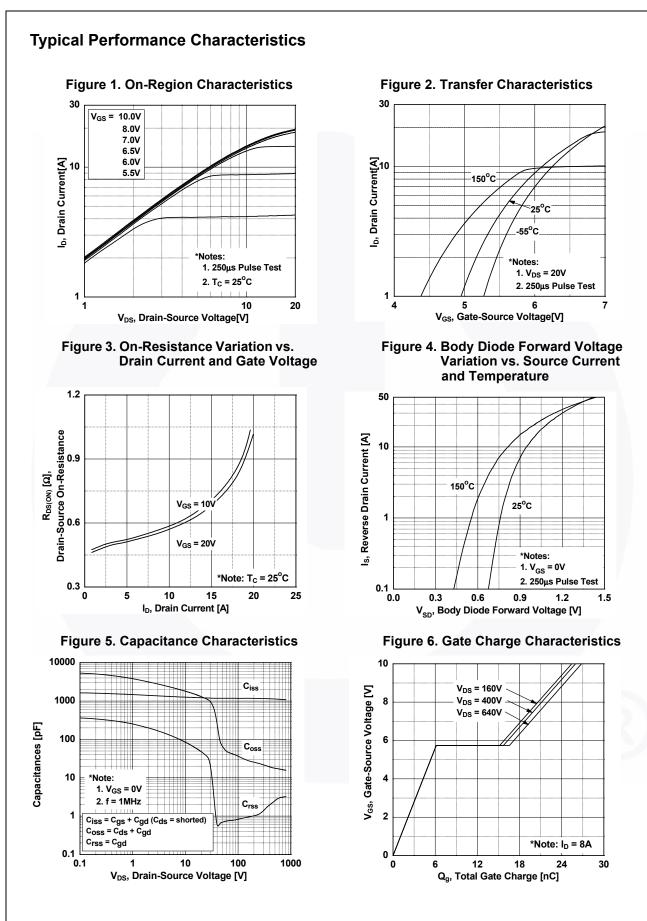
Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

| | FCPF650N80Z | Unit | | | |
|--|--|--|---|--|--|
| Drain to Source Voltage | 800 | V | | | |
| | - DC | - DC | | V | |
| Gate to Source voltage | - AC | - AC (f > 1 Hz) | | | |
| Drain Current | - Continuous (T _C = 25 ^o C) | - Continuous (T _C = 25 ^o C) | | | |
| Drain Current | - Continuous (T _C = 100 ^o C) | | 6.3* | A | |
| Drain Current | - Pulsed | (Note 1) | 24* | А | |
| Single Pulsed Avalanche Energy (Note 2) | | | 204 | mJ | |
| Avalanche Current | | | 1.6 | А | |
| Repetitive Avalanche Energy (Note 1) | | | 0.305 | mJ | |
| MOSFET dv/dt | | | 100 | V/ns | |
| Peak Diode Recovery dv/dt (Note 3) | | | 20 | | |
| Dower Dissinction | (T _C = 25°C) | | 30.5 | W | |
| Power Dissipation | - Derate Above 25°C | | 0.24 | W/ºC | |
| Operating and Storage Temperature Range | | | -55 to +150 | °C | |
| Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds | | | 300 | °C | |
| | Gate to Source Voltage Gate to Source Voltage Drain Current Drain Current Single Pulsed Avalanche Energy Avalanche Current Repetitive Avalanche Energy MOSFET dv/dt Peak Diode Recovery dv/dt Power Dissipation Operating and Storage Temp | $ \begin{array}{c} - DC \\ \hline - AC \\ - AC \\ \hline - Continuous (T_{C} = 25^{\circ}C) \\ \hline - Continuous (T_{C} = 100^{\circ}C) \\ $ | $\begin{tabular}{ c c c c } \hline $Prime Formula (Interval Interval I$ | $\begin{array}{c c c c c c c } \hline Drain to Source Voltage & & & & & & & & & & & & & & & & & & &$ | |

Thermal Characteristics

| Symbol | Parameter | FCPF650N80Z | Unit |
|---------------------|---|-------------|-------|
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction to Case, Max. | 4.1 | °C/W |
| R_{\thetaJA} | Thermal Resistance, Junction to Ambient, Max. | 62.5 | - C/W |

| Part Nur | Part Number Top Mark Pa | | Pack | ackage Packing Method Reel S | | ize | Tape Widt | h Q | Quantity | | |
|--|--|---|----------|---|--|----------|-----------|------|----------|----------|--|
| FCPF650 | · · · · · | | TO-2 | | | N/A | | N/A | 5 | 50 units | |
| Electrica | l Char | acteristics T _C =2 | 5ºC unle | ss othe | erwise noted. | | | | | | |
| Symbol | | Parameter | | Test Conditions | | | Min. | Тур. | Max. | Unit | |
| Off Charac | teristic | s | | | | | | | | | |
| BV _{DSS} | | • | tage ' | Voo = | 0 V, I _D = 1 mA, T _J = | 25°C | 800 | - | - | V | |
| ΔBV_{DSS} | Drain to Source Breakdown Voltage Breakdown Voltage Temperature | | ~ | | | | 000 | | | | |
| $/\Delta T_{J}$ | Coefficient | | | $I_D = 1 \text{ mA}$, Referenced to 25° C | | | - | 0.8 | - | V/ºC | |
| | 7 | | | V _{DS} = | 800 V, V _{GS} = 0 V | | - | - | 25 | | |
| IDSS | Zero Ga | ate Voltage Drain Curren | τ | $V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$ | | | - | - | 250 | μA | |
| I _{GSS} | Gate to | Body Leakage Current | | $V_{GS} = \pm 20 V, V_{DS} = 0 V$ | | - | - | ±10 | μΑ | | |
| On Charac | teristic | s | | | | | | | | | |
| V _{GS(th)} | Gate Th | nreshold Voltage | , | V _{GS} = | V _{DS} , I _D = 0.8 mA | | 2.5 | - | 4.5 | V | |
| R _{DS(on)} | | rain to Source On Resis | | | 10 V, I _D = 4 A | | - | 530 | 650 | mΩ | |
| 9 _{FS} | Forward | d Transconductance | | | 20 V, I _D = 4 A | | - | 7.8 | - | S | |
| Dynamic C | haracte | eristics | | | | | | 1 | | 1 | |
| C _{iss} | | apacitance | | | | | | 1178 | 1565 | pF | |
| C _{oss} | - | Capacitance | | − V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz | | - | 36 | 48 | pF | | |
| C _{rss} | | e Transfer Capacitance | 1 | | | | 0.84 | - | pF | | |
| C _{oss} | | Capacitance | , | V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz | | | - | 18 | - | pF | |
| C _{oss (eff.)} | | Effective Output Capacitance | | $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, 1 = 1 \text{ WHZ}$ $V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$ | | | - | 124 | - | pF | |
| Q _{g(tot)} | | ate Charge at 10V | | | | •• | - | 27 | 35 | nC | |
| Q_{gs} | | Source Gate Charge | | V _{DS} = 640 V, I _D = 8 A, V _{GS} = 10 V | | - | 6 | - | nC | | |
| Q _{gd} | | Drain "Miller" Charge | | GS | | (Note 4) | - | 11 | - | nC | |
| ESR | | ent Series Resistance | 1 | f = 1 N | IHz | . , | - | 1.9 | - | Ω | |
| | - · · | | | | | | | | | | |
| Switching | Charac | teristics | | | | | | | | | |
| t _{d(on)} | Turn-Or | n Delay Time | | $V_{DD} = 400 \text{ V}, \text{ I}_{D} = 8 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$ (Note 4) | | - | 17 | 44 | ns | | |
| t _r | | n Rise Time | | | | - | 11 | 32 | ns | | |
| t _{d(off)} | | f Delay Time | | | | - / | 40 | 90 | ns | | |
| t _f | Turn-Of | f Fall Time | | | | - | 3.4 | 17 | ns | | |
| Drain-Sou | rce Dio | de Characteristics | | | | | | | | | |
| Is | Maximu | m Continuous Drain to S | ource Di | ode Fo | orward Current | | - | - | 10 | Α | |
| I _{SM} | Maximu | m Pulsed Drain to Sourc | e Diode | Forwa | rd Current | | - | - | 24 | Α | |
| V _{SD} | Drain to | Source Diode Forward | Voltage | V _{GS} = | 0 V, I _{SD} = 8 A | | - | - | 1.2 | V | |
| t _{rr} | Reverse | Recovery Time | | $V_{GS} = 0 V, I_{SD} = 8 A,$ $dI_F/dt = 100 A/\mu s$ | | - | 365 | - | ns | | |
| Q _{rr} | Reverse | Recovery Charge | | | | - | 5.9 | - | μC | | |
| . I _{AS} = 1.6 A, R _G : . I _{SD} ≤ 10 A, di/dt | = 25 Ω, Startin ≤ 200 A/μs, \ | limited by maximum junction ten ng T _J = 25°C $/_{DD} \le BV_{DSS}$, Starting T _J = 25°C verating temperature typical char: | | | | | | | | | |

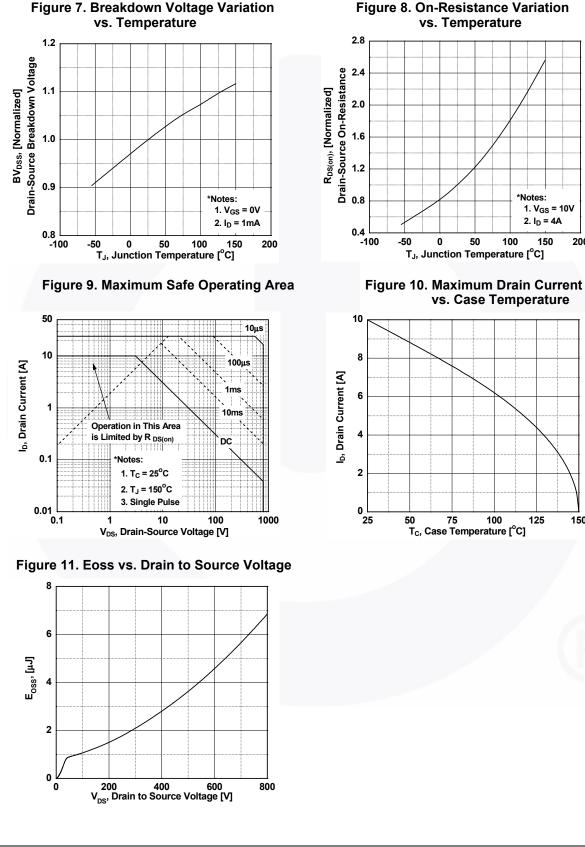


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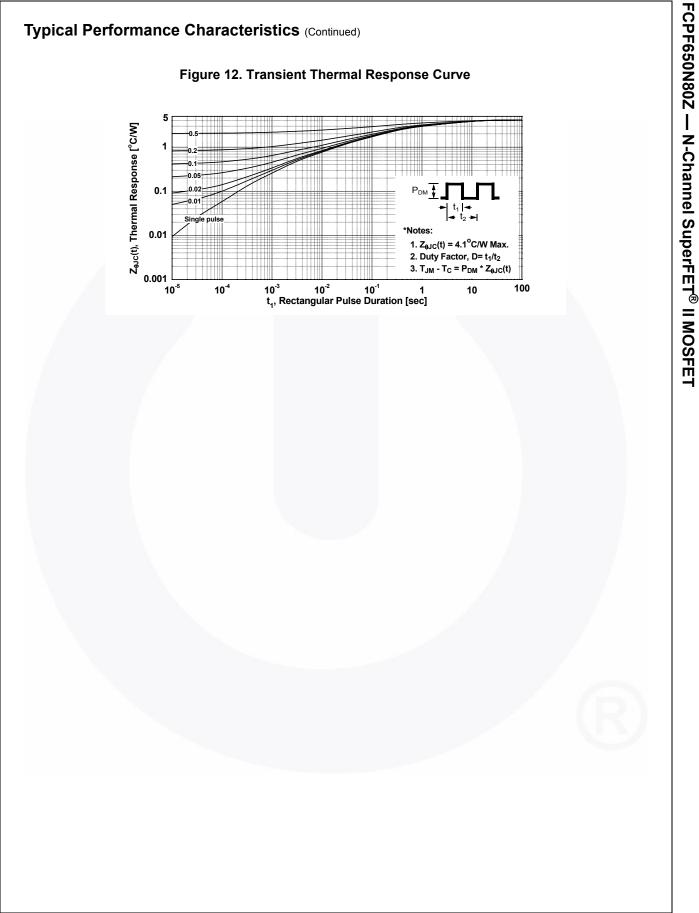


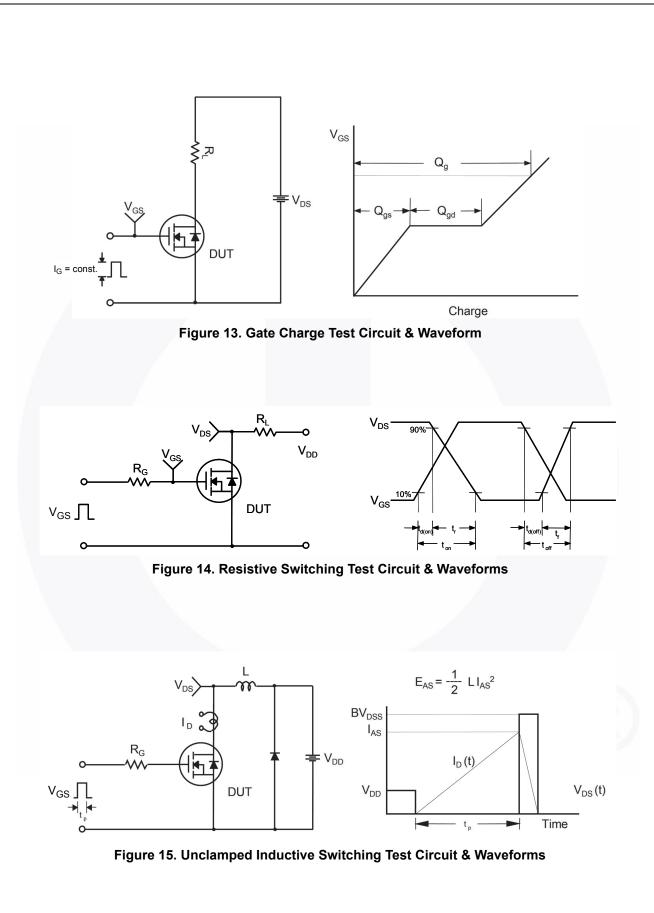
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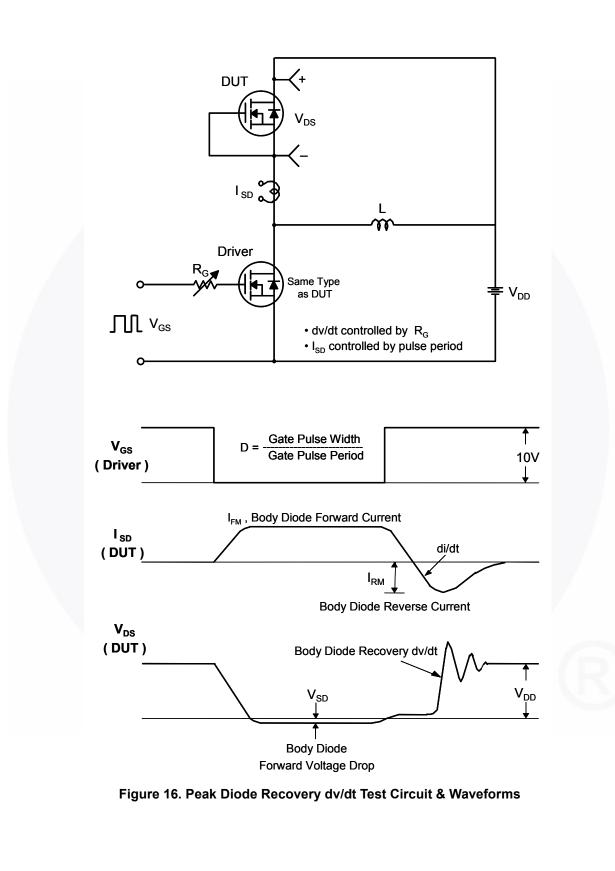


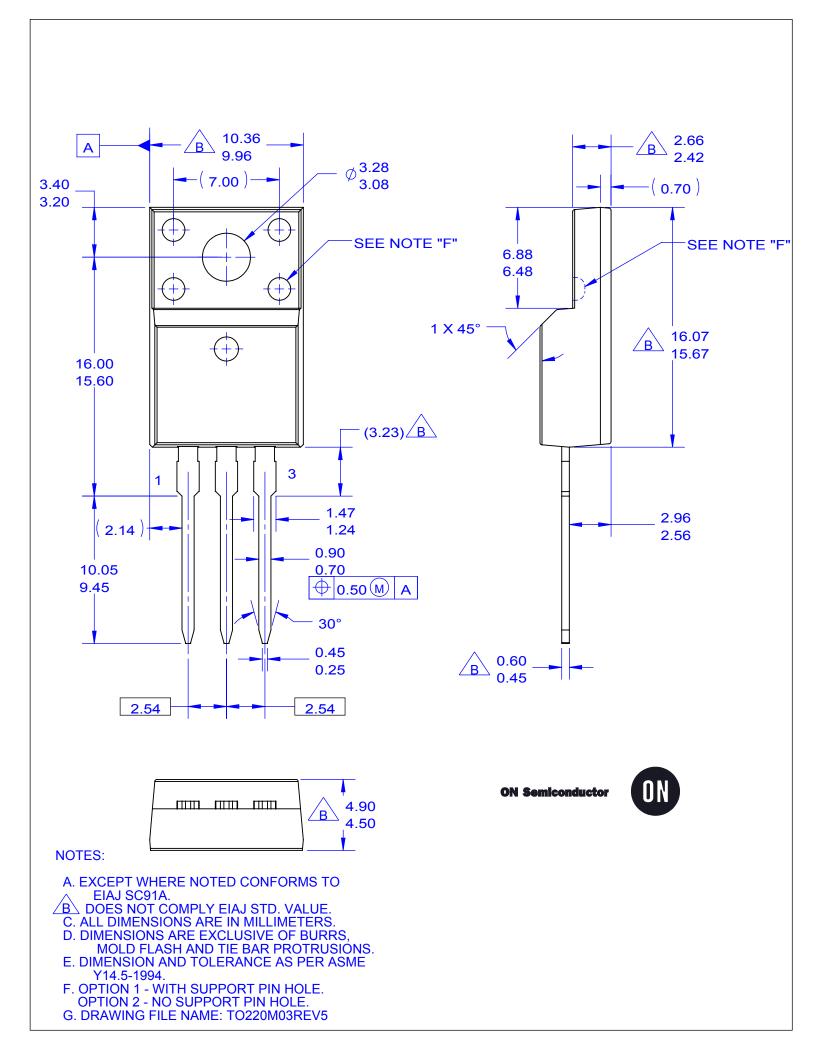
Typical Performance Characteristics (Continued)





FCPF650N80Z — N-Channel SuperFET[®] II MOSFET





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